



## 3-Phase High Voltage Gate Drive IC

### General Description

The ID7T6036 is a three-phase gate drive IC which can be used to drive N-channel power MOSFETs or IGBTs in the high side configuration which operates up to 600V. Logic inputs are compatible with CMOS or LSTTL outputs, down to 3.3V logic. A current trip function which terminates all six outputs can be derived from an external current sense resistor. An enable function is available to terminate all six outputs simultaneously. An open-drain FAULT signal is provided to indicate that an over-current or under-voltage shutdown has occurred. Over-current fault conditions are cleared automatically after a delay programmed externally via an RC network connected to the RCIN input. The output drivers feature a high pulse current buffer stage designed for minimum driver cross-conduction. Propagation delays are matched to simplify use in high frequency applications.

### Features

- Operation to +600 V
- Typically 200mA/350mA Source/Sink current
- 3.3 V/5V/15V input logic compatible
- dV/dt Immunity ±50 V/nsec
- Typically - 9V negative Vs bias capability
- Gate drive supply range from 10 V to 20 V
- UVLO for all channels
- Cross-conduction prevention logic
- Over-current shutdown turns off all six drivers
- Externally adjustable Fault-clear timing
- Built-in advanced input filter
- Matched propagation delay for all channels

### Applications

- Sewing Machine/Power Tool
- Air Conditioners/ Washing Machines /Refrigerator
- General Purpose Inverters

### Package Options

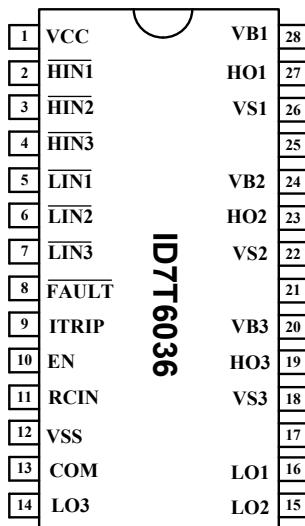
#### 28-SOIC



### Order Information

Part Number	Order Code	Package	Type
ID7T6036	ID7T6036SAC-R1	SOIC28	Reel

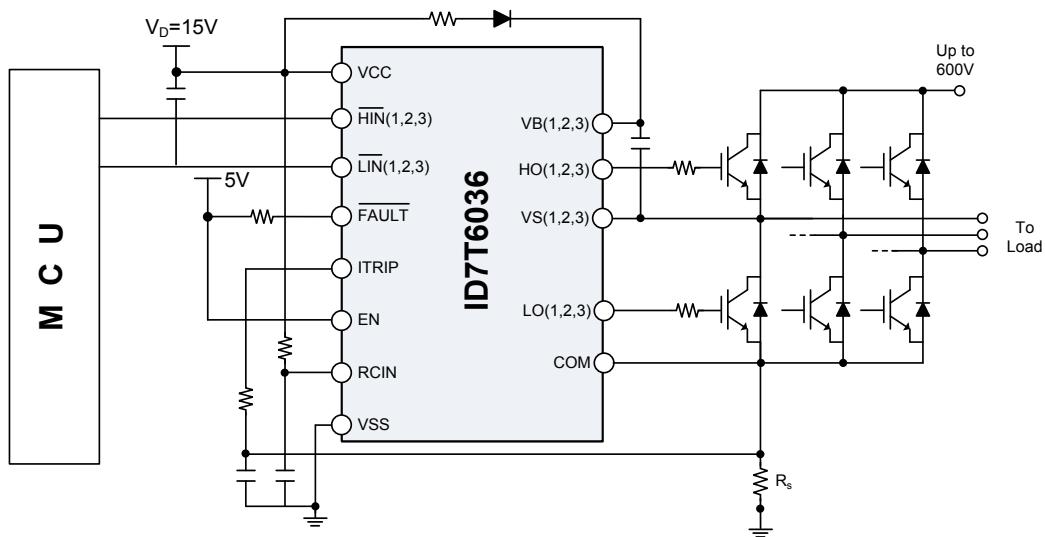
## Pin Configuration



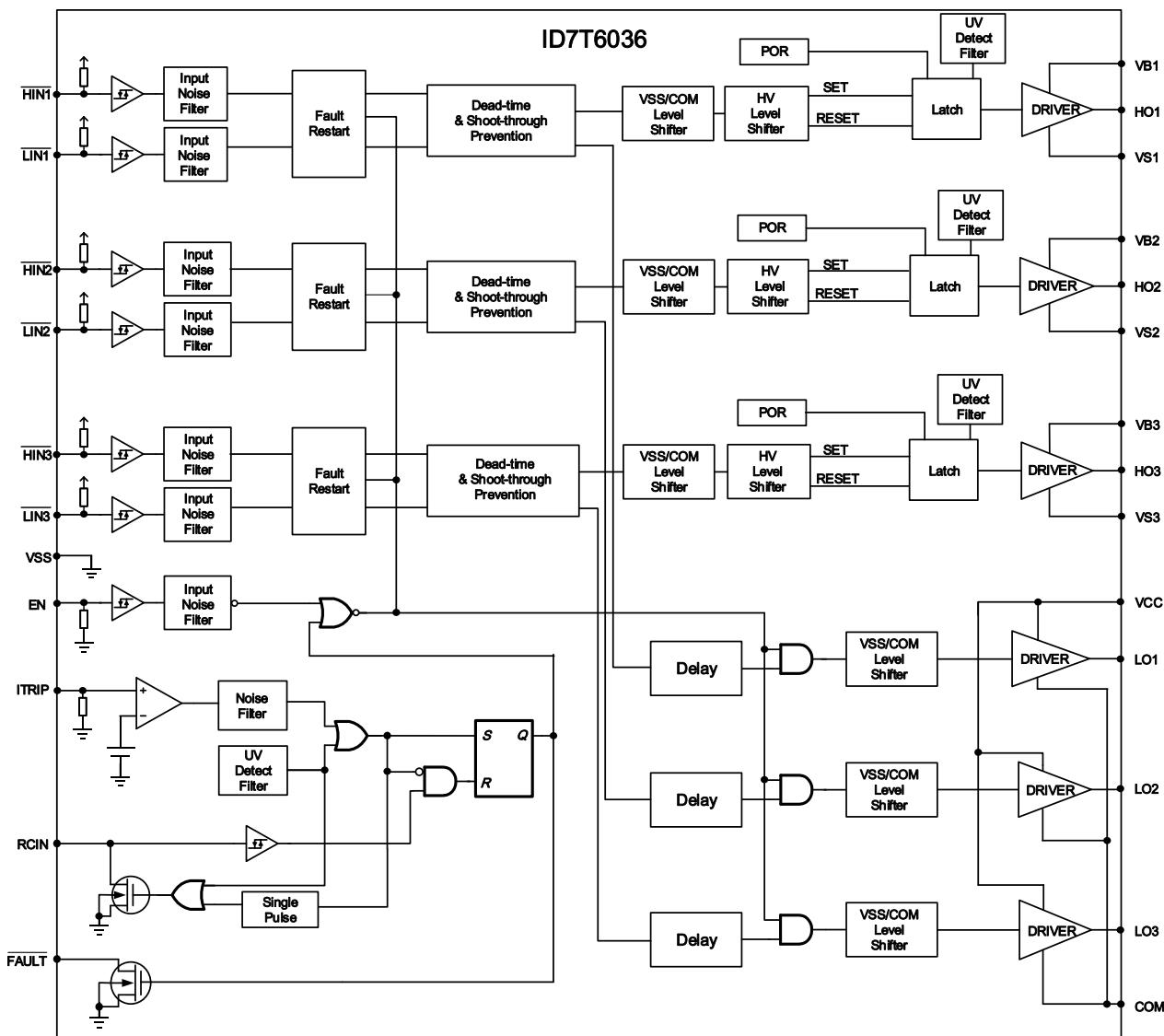
## Pin Definitions

PIN NO.	PIN NAME	PIN FUNCTION
1	VCC	Low side and logic fixed supply voltage
2	HIN1	Signal Input for 1 Phase High-side
3	HIN2	Signal Input for 2 Phase High-side
4	HIN3	Signal Input for 3 Phase High-side
5	LIN1	Signal Input for 1 Phase Low-side
6	LIN2	Signal Input for 2 Phase Low-side
7	LIN3	Signal Input for 3 Phase Low-side
8	FAULT	Indicates over-current (ITRIP) or low-side under-voltage lockout
9	ITRIP	Analog input for overcurrent shutdown.
10	EN	Logic input to enable I/O functionality
11	RCIN	External RC network input used to define FAULT CLEAR delay
12	VSS	Logic ground
13	COM	Low side gate drivers return
14	LO3	Low side gate driver outputs for 3 Phase
15	LO2	Low side gate driver outputs for 2 Phase
16	LO1	Low side gate driver outputs for 1 Phase
18	VS3	High voltage floating supply return for 3 Phase
19	HO3	High side gate driver outputs for 3 Phase
20	VB3	High side floating supply for 3 Phase
22	VS2	High voltage floating supply return for 2 Phase
23	HO2	High side gate driver outputs for 2 Phase
24	VB2	High side floating supply for 2 Phase
26	VS1	High voltage floating supply return for 1 Phase
27	HO1	High side gate driver outputs for 1 Phase
28	VB1	High side floating supply for 1 Phase

## Typical Application Circuit



## Functional Block Diagram



## Absolute Maximum Ratings

Exceeding these ratings may damage the device.

The absolute maximum ratings are stress ratings only at  $T_A=25^\circ\text{C}$ , unless otherwise specified.

Symbol	Definition	MIN.	MAX.	Units
VB(1,2,3)	High side floating supply	-0.3	620	V
VS(1,2,3)	High side floating supply return	$V_B - 20$	$V_B + 0.3$	
VHO(1,2,3)	High side gate drive output	$V_S - 0.3$	$V_B + 0.3$	
VCC	Low side and main power supply	-0.3	20	
VLO(1,2,3)	Low side gate drive output	COM -0.3	$V_{CC} + 0.3$	
VIN	Logic input of $\overline{HIN}$ & $\overline{LIN}$	$V_{SS} - 0.3$	$V_{CC} + 0.3$	
VSS	Logic ground	$V_{CC} - 20$	$V_{CC} + 0.3$	
VRCIN	RCIN input voltage	$V_{SS}$	$V_{CC}$	
VFLT	$\overline{FAULT}$ output voltage	$V_{SS} - 0.3$	$V_{CC} + 0.3$	
dVS/dt	Allowable Offset Supply Voltage Transient	—	50	V/ns
ESD	HBM Model	2.5	—	kV
	Machine Model	200	—	V
P <sub>D</sub>	Package Power Dissipation @ $TA \leq 25^\circ\text{C}$	28 Lead SOIC	—	W
R <sub>thJA</sub>	Thermal Resistance Junction to Ambient	28 Lead SOIC	—	$^\circ\text{C}/\text{W}$
T <sub>J</sub>	Junction Temperature	—	150	$^\circ\text{C}$
T <sub>S</sub>	Storage Temperature	-55	150	
T <sub>L</sub>	Lead Temperature (Soldering, 10 seconds)	—	300	

## Recommended Operating Conditions

Symbol	Definition	MIN.	MAX.	Units
VB(1,2,3)	High side floating supply	VS +10	VS +20	V
VS(1,2,3)	High side floating supply return	COM -9	600	
VHO(1,2,3)	High side gate drive output voltage	VS1,2,3	VB,1,2,3	
VCC	Low side supply	10	20	
VLO(1,2,3)	Low side gate drive output voltage	0	VCC	
VIN	Logic input voltage( $\overline{HIN}$ & $\overline{LIN}$ )	0	VCC	
VSS	Logic ground	-5	5	
VRCIN	RCIN input voltage	VSS	VCC	
VFLT	$\overline{FAULT}$ output voltage	VSS	VCC	
T <sub>A</sub>	Ambient temperature	-40	125	$^\circ\text{C}$

## Dynamic Electrical Characteristics

VBIAS (VCC, VBS) = 15V, C<sub>L</sub> = 1000 pF and T<sub>A</sub> = 25°C unless otherwise specified.

Symbol	Definition	MIN.	TYP.	MAX.	Units
t <sub>ON</sub>	Turn on propagation delay	400	530	750	ns
t <sub>OFF</sub>	Turn off propagation delay	400	530	750	
t <sub>R</sub>	Turn on rising time	-	125	190	
t <sub>F</sub>	Turn off falling time	-	50	75	
t <sub>IN,FLT</sub>	Input filter time ( <u>HIN,LIN</u> )	200	350	510	
t <sub>EN</sub>	Enable low to output shutdown propagation delay	350	460	650	
t <sub>EN,FLT</sub>	Enable input filter time	100	200	-	μs
t <sub>UVCC</sub>	UVCC filter time	-	7	-	
t <sub>UVBS</sub>	UVBS filter time	-	7	-	
t <sub>UVCC,FO</sub>	UVCC to FAULT shutdown propagation delay	-	7	-	
t <sub>UVCC,LO</sub>	UVCC to LO shutdown propagation delay	-	7	-	
t <sub>UVBS,HO</sub>	UVBS to HO shutdown propagation delay	-	7	-	
t <sub>FOd</sub>	FAULT output duration time (RCIN: C = 1nF, R = 2 MΩ)	1.3	1.65	2	ms
t <sub>ITRIP</sub>	ITRIP to output shutdown propagation delay	420	620	970	ns
t <sub>IT,FLT</sub>	ITRIP filter time	-	400	-	
t <sub>FO</sub>	ITRIP to FAULT propagation delay	400	600	950	
DT	Deadtime	190	275	420	
MDT	DT Matching	-	-	60	
MT	Delay matching time (t <sub>ON</sub> , t <sub>OFF</sub> )	-	-	50	
PM	Pulse width distortion <sup>[1]</sup>	-	-	75	

### Notes:

1. PM is defined as PW<sub>IN</sub>-PW<sub>OUT</sub>

## Static Electrical Characteristics

V<sub>BIAS</sub> (V<sub>CC</sub>, V<sub>BS</sub>) = 15V, C<sub>L</sub> = 1000 pF and T<sub>A</sub> = 25°C unless otherwise specified.

Symbol	Definition	MIN.	TYP.	MAX.	Units
V <sub>UVCC+</sub>	V <sub>CC</sub> supply undervoltage positive going threshold	8	8.9	9.8	V
V <sub>UVCC-</sub>	V <sub>CC</sub> supply undervoltage negative going threshold	7.4	8.2	9.0	
V <sub>UVCHY</sub>	V <sub>CC</sub> supply undervoltage hysteresis	0.3	0.7	-	
I <sub>LK</sub>	High-side floating supply leakage current	-	-	50	μA
I <sub>QBS</sub>	Quiescent V <sub>BS</sub> supply current	-	70	120	
I <sub>QCC</sub>	Quiescent V <sub>CC</sub> supply current	-	1	2	mA
I <sub>PBS</sub>	Operating V <sub>BS</sub> supply current	-	400	600	μA
I <sub>PC</sub>	Operating V <sub>CC</sub> supply current (per 1phase)	-	1.3	1.8	mA
V <sub>OH</sub>	High level output voltage drop, V <sub>BIAS</sub> - V <sub>O</sub>	-	0.9	1.4	V
V <sub>OL</sub>	Low level output voltage drop, V <sub>O</sub>	-	0.4	0.6	
I <sub>O+</sub>	Output high short circuit pulsed current	120	200	-	
I <sub>O-</sub>	Output low short circuit pulsed current	250	350	-	mA
V <sub>IH</sub>	High level input threshold voltage	2.5	-	-	V
V <sub>IL</sub>	Low level input threshold voltage	-	-	0.8	
V <sub>CLAMP</sub>	Input clamp voltage ( HIN,LIN , ITRIP, EN)	5.2	5.6	5.9	
I <sub>HIN+</sub>	Input bias current (HO = High)	-	150	200	μA
I <sub>HIN-</sub>	Input bias current (HO = Low)	-	110	150	
I <sub>LIN+</sub>	Input bias current (LO = High)	-	150	200	
I <sub>LIN-</sub>	Input bias current (LO = Low)	-	110	150	
V <sub>RCIN,TH</sub>	RCIN positive going threshold	-	8	-	V
V <sub>RCIN,HY</sub>	RCIN hysteresis	-	3	-	
I <sub>RCIN</sub>	RCIN input bias current	-	-	1	μA
R <sub>RCIN,ON</sub>	RCIN low on resistance	-	50	100	Ω
V <sub>IT,TH+</sub>	ITRIP positive going threshold	0.42	0.46	0.5	V
V <sub>IT,TH-</sub>	ITRIP negative going threshold	-	0.4	0.49	
V <sub>IT,HY</sub>	ITRIP hysteresis	-	0.06	-	
I <sub>ITRIP+</sub>	“High” ITRIP input bias current	-	5	40	μA
I <sub>ITRIP-</sub>	“Low” ITRIP input bias current	-	-	1	
V <sub>EN,TH+</sub>	Enable positive going threshold	-	-	2.5	V
V <sub>EN,TH-</sub>	Enable negative going threshold	0.8	-	-	
I <sub>EN+</sub>	“High” Enable input bias current	-	5	40	μA
I <sub>EN-</sub>	“Low” Enable input bias current	-	-	1	
R <sub>FO,ON</sub>	FAULT low on resistance	-	50	100	Ω

## Function Timing Diagram

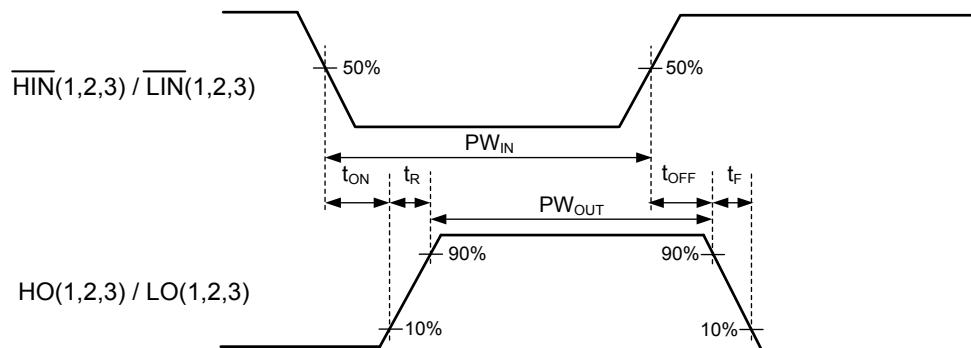


Fig.1 Switching timing waveform

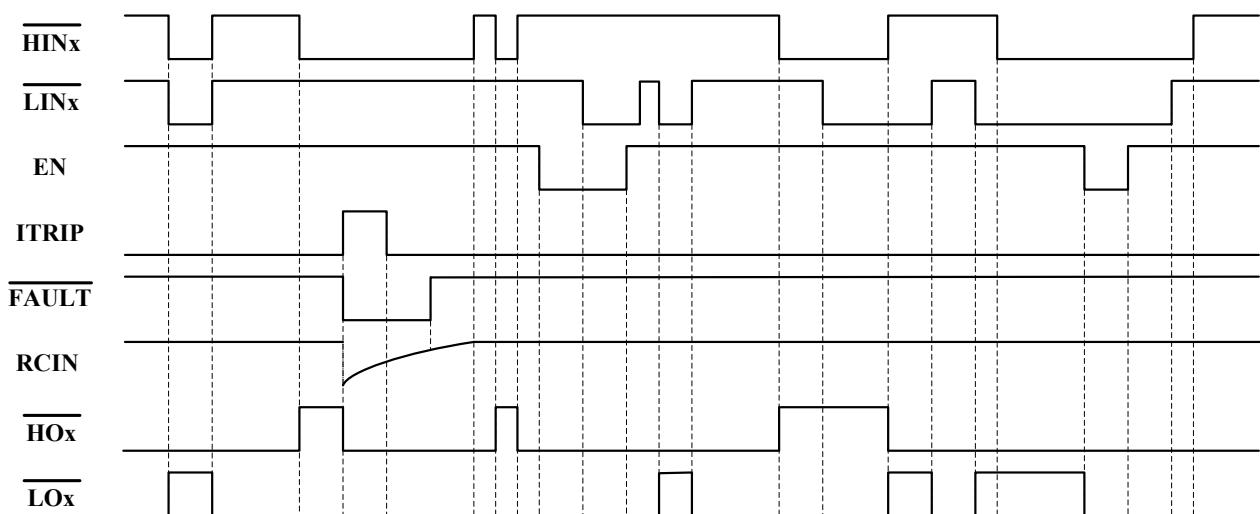


Fig.2 Input/Output timing waveform

## Characterization Curves

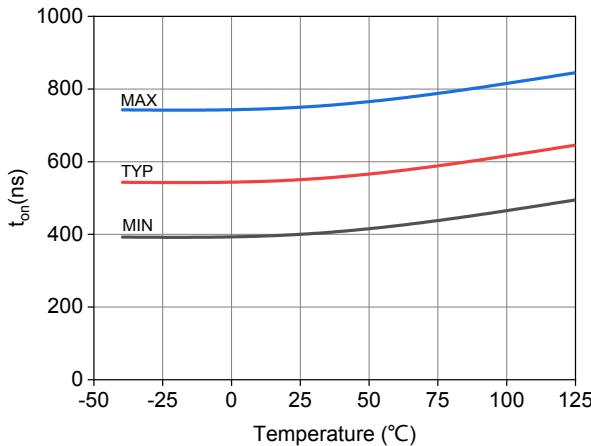
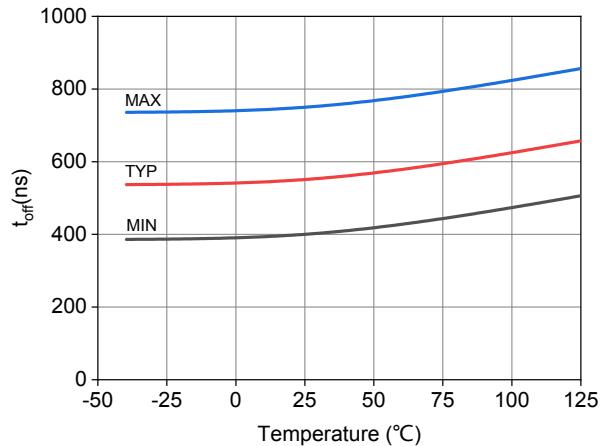
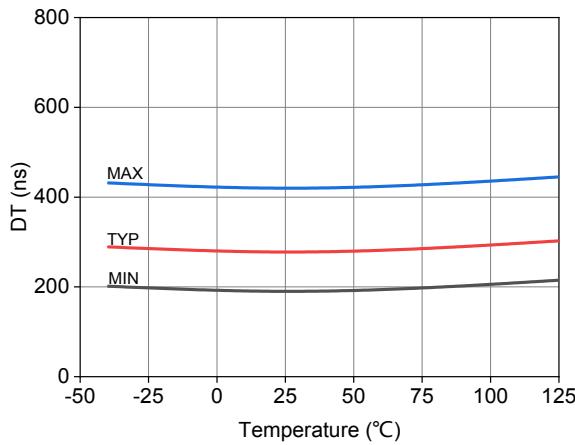
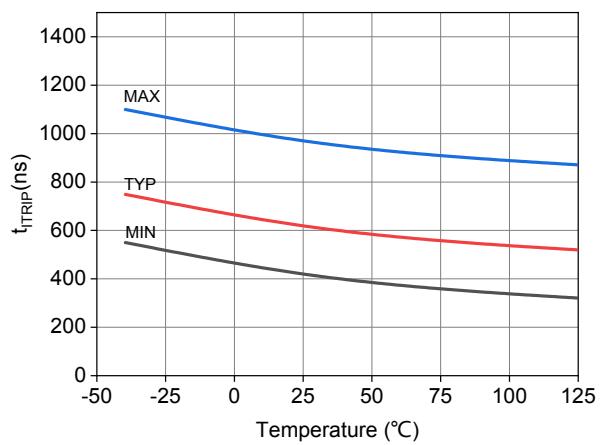
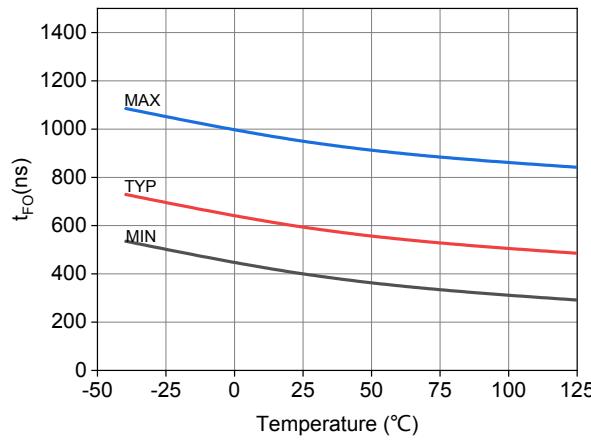
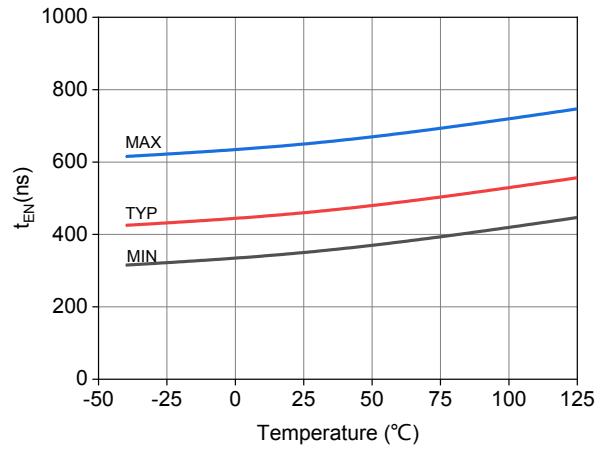
Figure 3:  $t_{ON}$  vs. temperatureFigure 4:  $t_{OFF}$  vs. temperature

Figure 5: DT vs. temperature

Figure 6:  $t_{ITRIP}$  vs. temperatureFigure 7:  $t_{FO}$  vs. temperatureFigure 8:  $t_{EN}$  vs. temperature

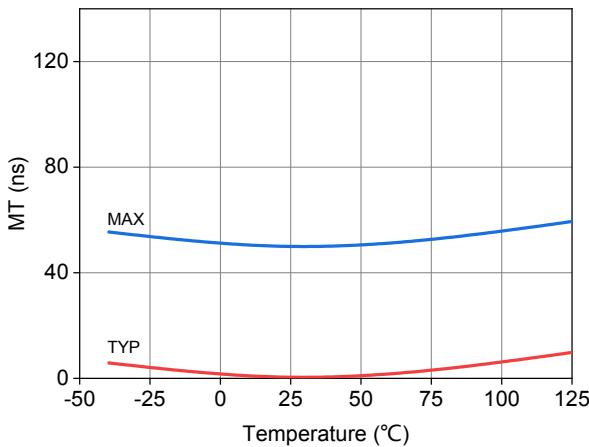


Figure 9: MT vs. temperature Figure

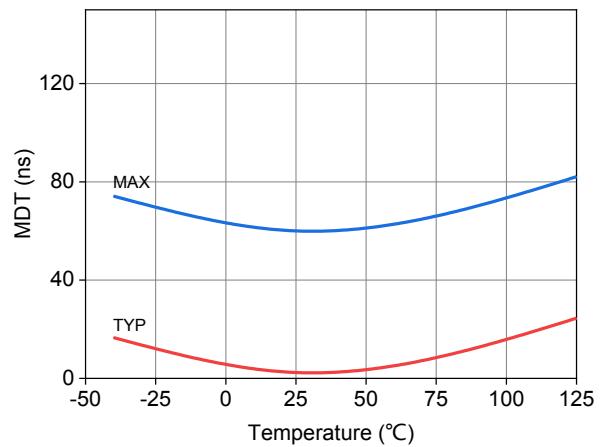


Figure 10: MDT vs. temperature

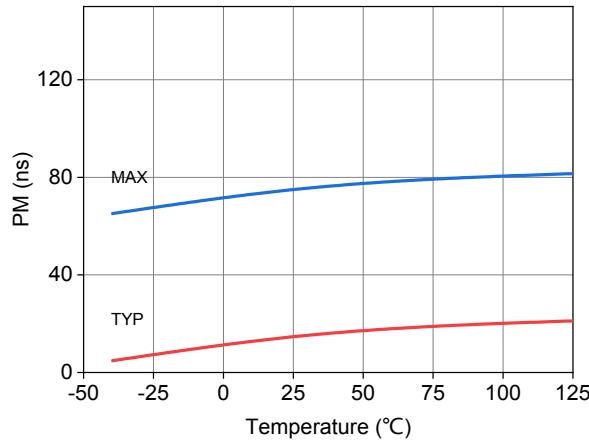


Figure 11: PM vs. temperature Figure

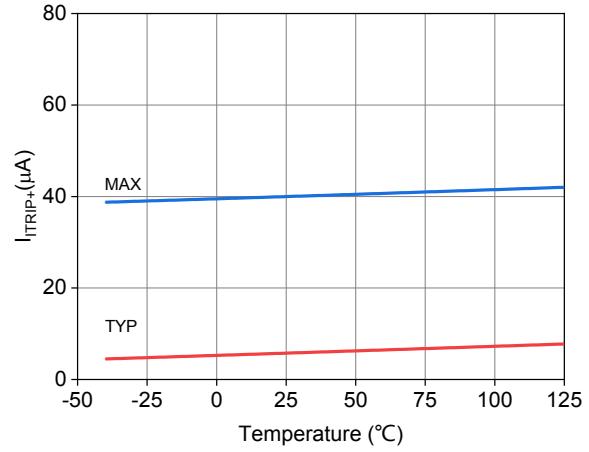
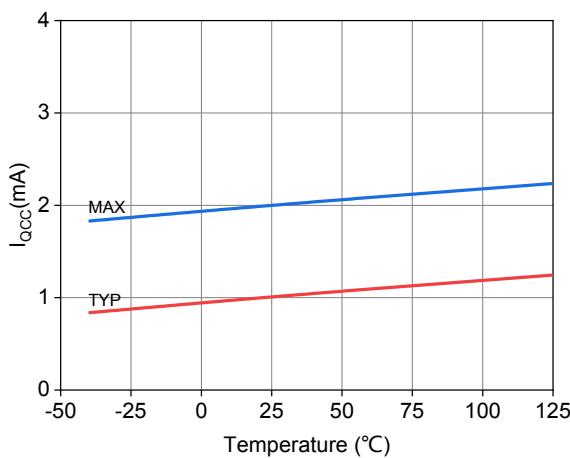
Figure 12: I<sub>TRIP+</sub> vs. temperature

Figure 13: IQCC vs. temperature Figure

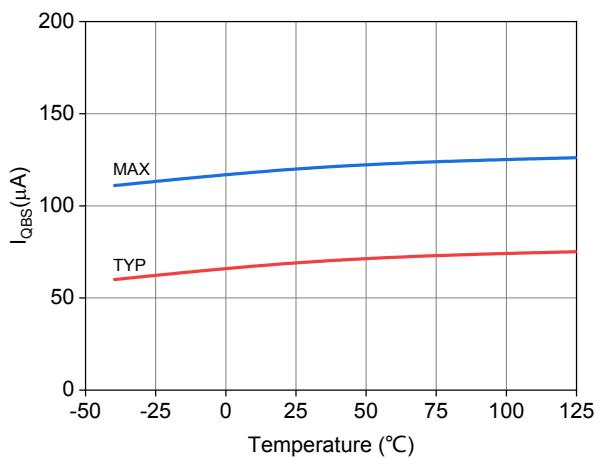


Figure 14: IQBS vs. temperature

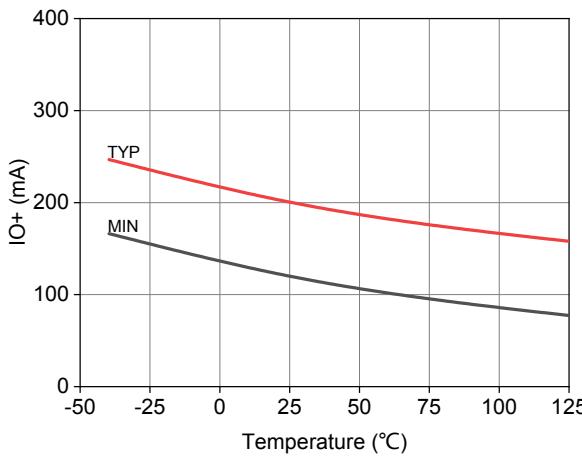


Figure 15: IO+ vs. temperature Figure

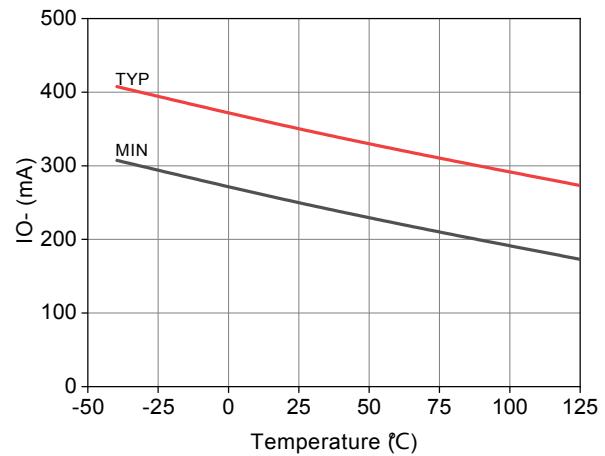
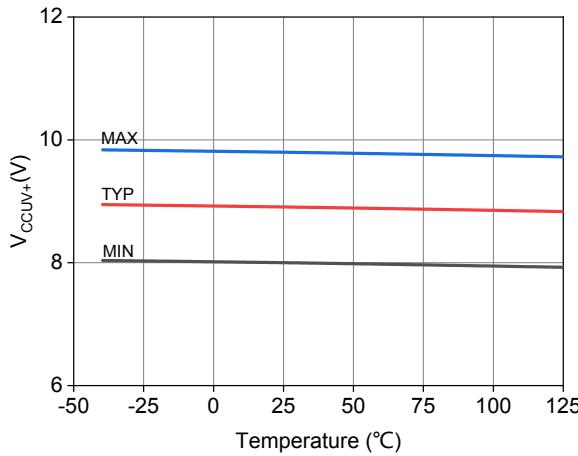
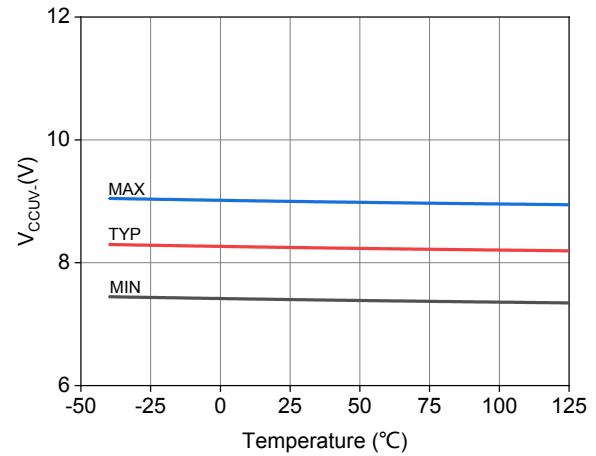
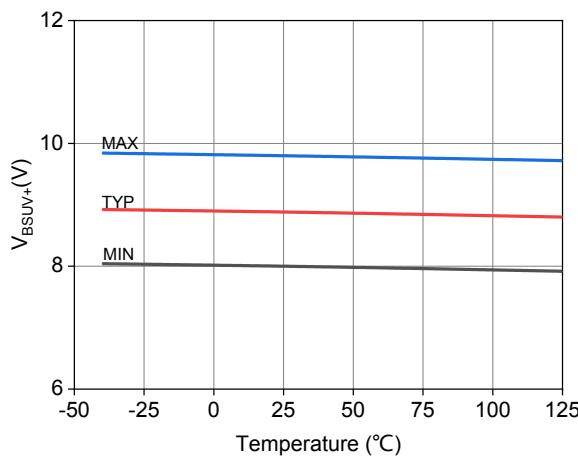
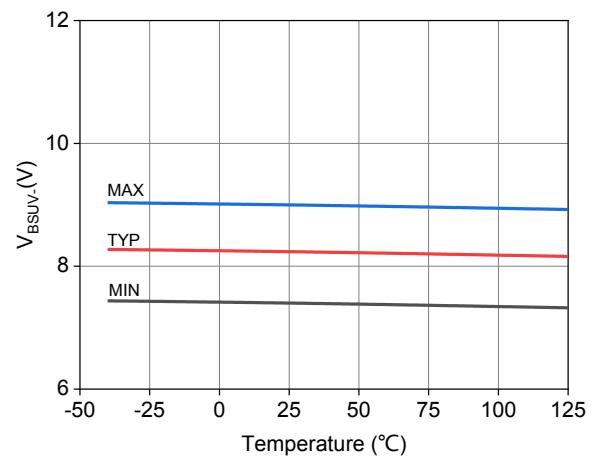
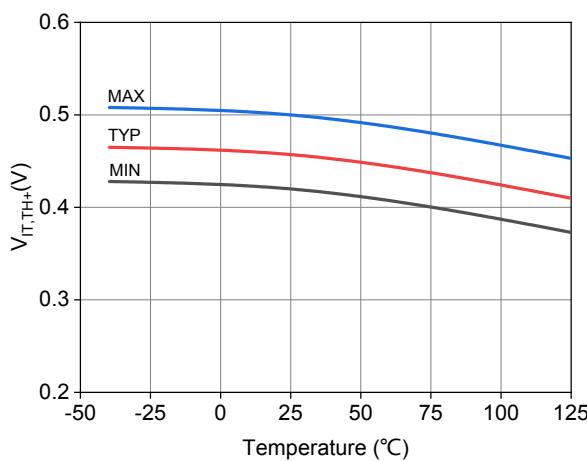
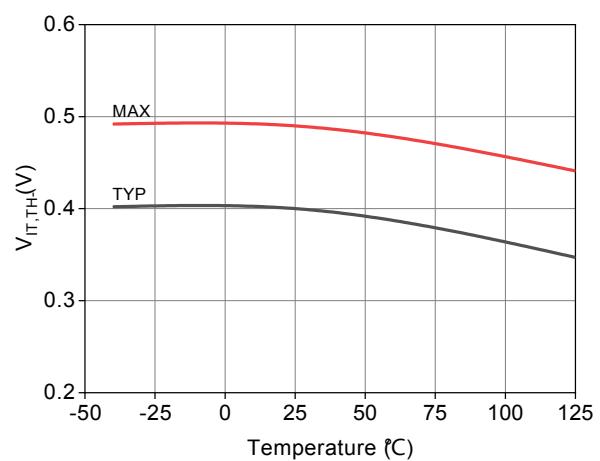
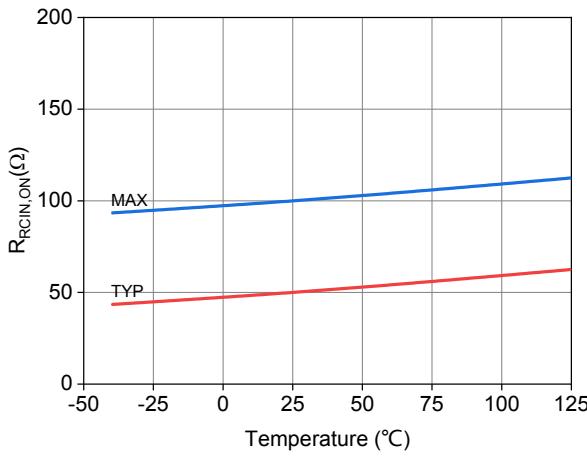
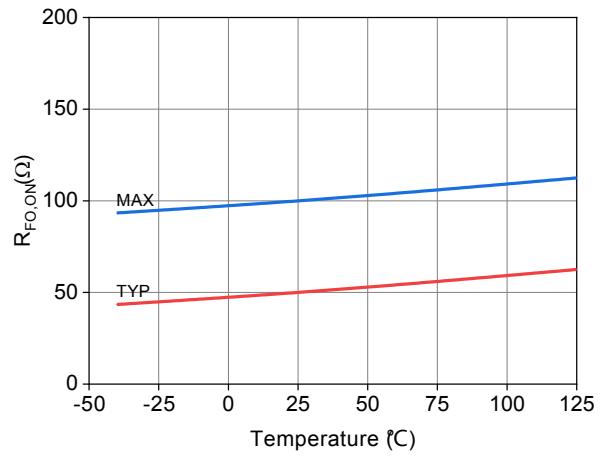


Figure 16: IO- vs. temperature

Figure 17: V<sub>CCUV+</sub> vs. temperature FigureFigure 18: V<sub>CCUV-</sub> vs. temperatureFigure 19: V<sub>B<sub>S</sub>UV+</sub> vs. temperature FigureFigure 20: V<sub>B<sub>S</sub>UV-</sub> vs. temperature

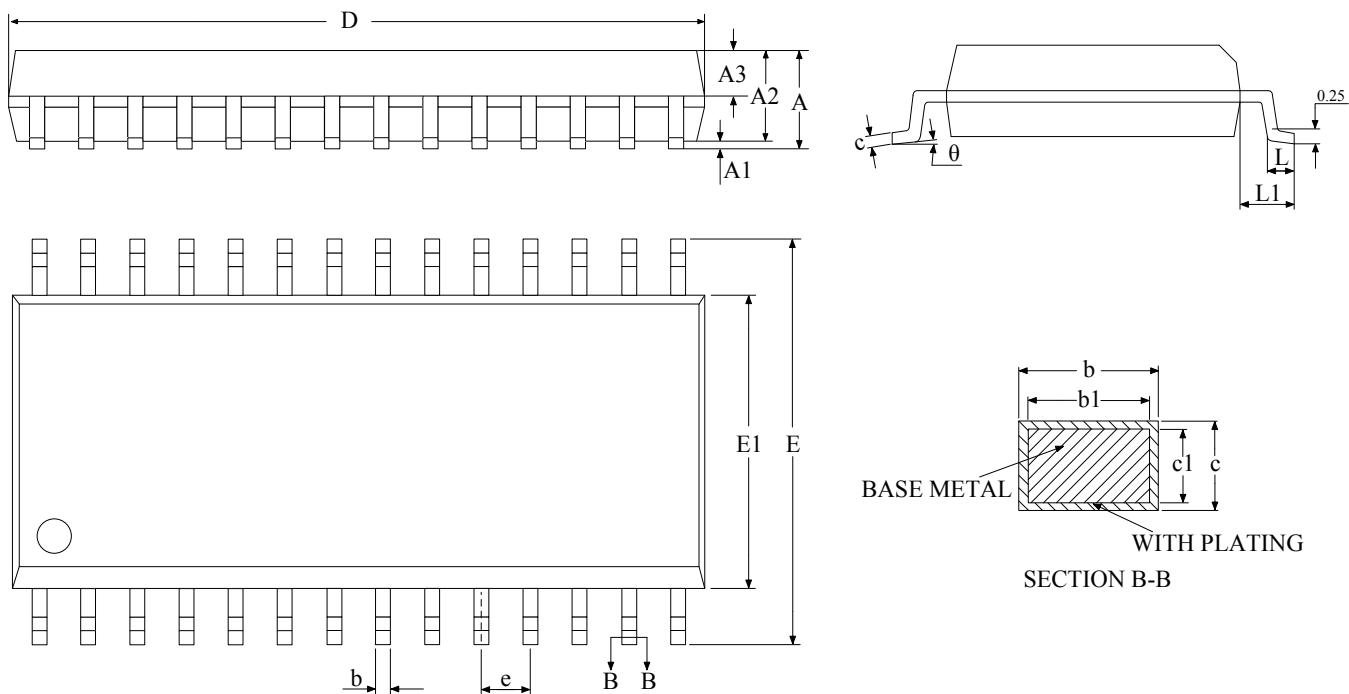
Figure 21:  $V_{IT,TH^+}$  vs. temperatureFigure 22:  $V_{IT,TH^-}$  vs. temperatureFigure 23:  $R_{RCIN,ON}$  vs. temperatureFigure 24:  $R_{FO,ON}$  vs. temperature

## Package Information

### SOIC28 Package Dimensions

Size Symbol	MIN(mm)	TYP(mm)	MAX(mm)	Size Symbol	MIN(mm)	TYP(mm)	MAX(mm)
A	-	-	2.65	D	17.89	18.09	18.29
A1	0.10	-	0.30	E	10.10	10.30	10.50
A2	2.25	2.30	2.35	E1	7.30	7.50	7.70
A3	0.97	1.02	1.07	e	1.27BSC		
b	0.39	-	0.48	L	0.70	-	1.00
b1	0.38	0.41	0.43	L1	1.40BSC		
c	0.25	-	0.31	θ	0	-	8°
c1	0.24	0.25	0.26				

### SOIC28 Package Outlines



Mark	Package
ID7T6036 ABYW <sub>X</sub>	SOIC28

Note : AB : Product code , Y : Year code ; W : Week code ; X : Package code